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Execution Date: 30 September 1999

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4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: 30 Sept. 1999

A. Patent Application No.(s)

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5. Name and address of party to whom correspondence concerning document should be mailed:

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6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$ 40.00

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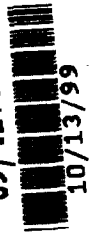
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# ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned,

Akio HASHIMOTO

hereby sell, assign and transfer to

TEIJIN SEIKI CO., LTD., a corporation of Japan

of 9-1, Edobori 1-chome, Nishi-ku, Osaka-shi, Osaka, Japan

(hereinafter called the Assignee) the entire right, title, and interest in and to any and all improvements which are disclosed in the application for United States Letters Patent entitled

Sealing Mechanism for Sealing a Vacuum Chamber

which application was

(a) executed by the undersigned on the 30th day of September, 1999

(b) filed on the \_\_\_\_\_ day of \_\_\_\_\_ 1999, Serial No. \_\_\_\_\_

including any and all United States Letters Patents which may be granted therefor and any and all extensions, divisions, reissues, substitutes or renewals thereof and the right to all benefits under the International Convention for the Protection of Industrial Property.

It is hereby authorized and requested that the Commissioner of Patents issue any and all of said Letters Patent, when granted, to said Assignee.

Further, it is agreed that, when requested, without charge to but at the expense of said Assignee, the undersigned will execute all divisional, substitute, renewal, and reissue patent applications; execute all rightful other papers; and generally do everything possible which said Assignee shall consider desirable for aiding in securing and maintaining proper patent protection.

Signed at Mie, Japan, this 30th day of September, 1999

INVENTOR(S):

Akio Hashimoto  
Akio HASHIMOTO

WITNESS:

Tomio Miyamoto